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Media Alert: Intel Accelerated Webcast on July 26

Join Intel CEO Pat Gelsinger for a webcast detailing the company's process and packaging innovations.

SANTA CLARA, Calif.--(BUSINESS WIRE)-- Intel is accelerating its annual cadence of innovation with new advancements in semiconductor process and packaging as part of its [IDM 2.0 strategy](#).

This press release features multimedia. View the full release here: <https://www.businesswire.com/news/home/20210712005123/en/>



Join a webcast with CEO [Pat Gelsinger](#) and [Dr. Ann Kelleher](#), senior vice president and general manager of Technology Development, where they will provide a deeper look at Intel's process and packaging roadmaps.

When: 2 p.m. PDT, Monday, July 26

Where: Watch live on the [Intel Newsroom](#).

Event Replay: A

video replay will be available on the Intel Newsroom following the webcast.

Updates: To receive updates on the news, visit the [Intel Newsroom](#) and follow along on Twitter with [@IntelNews](#).

More: [Process & Packaging Innovations](#) (Press Kit)

About Intel

Intel (Nasdaq: INTC) is an industry leader, creating world-changing technology that enables global progress and enriches lives. Inspired by Moore's Law, we continuously work to advance the design and manufacturing of semiconductors to help address our customers'

greatest challenges. By embedding intelligence in the cloud, network, edge and every kind of computing device, we unleash the potential of data to transform business and society for the better. To learn more about Intel's innovations, go to newsroom.intel.com and intel.com.

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